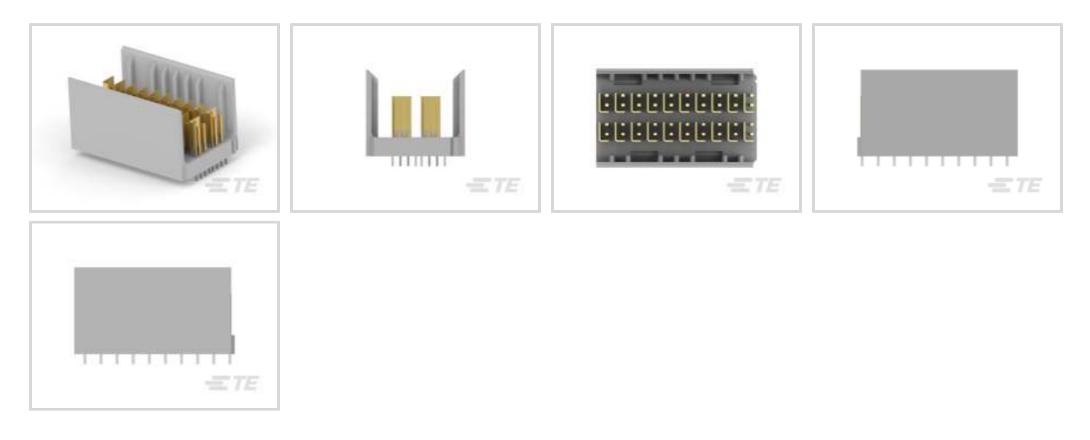


# Z-PACK | Z-PACK HM-Zd+

TE Internal #: 2170328-1 High Speed Backplane Connectors, 40 Position, Mating Alignment, Center & Dual Mating Alignment Type, 2 Row, 10 Column, PCB Mount Header, Z-PACK HM-Zd+

### View on TE.com >

Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: **Board-to-Board** Number of Positions: **40** 

Row-to-Row Spacing: 3 mm [.118 in ]

Mating Alignment: With

Mating Alignment Type: Center & Dual

# Features

**E** 

### **Product Type Features**

Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Signal Positions	2
Number of Positions	40
Number of Rows	2
Number of Columns	10
PCB Mount Orientation	Vertical
Guide Location	Unguided
Electrical Characteristics	
Operating Voltage	250 VAC
Signal Characteristics	

High Speed Backplane Connectors, 40 Position, Mating Alignment, Center & Dual Mating Alignment Type, 2 Row, 10 Column, PCB Mount Header, Z-PACK HM-Zd+



Number of Differential Pairs per Column	2
Data Rate	≤12 Gb/s
Body Features	
Primary Product Color	Gray
Contact Features	
Contact Type	Pin
Contact Mating Area Plating Material	Gold Flash over Palladium Nickel
Contact Underplating Material	Nickel
Contact Base Material	Brass, Phosphor Bronze
Contact Current Rating (Max)	.7 A
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Center & Dual
Connector Mounting Type	Board Mount

## Housing Features

Number of Shrouded Sides	2
Centerline (Pitch)	2.5 mm[.1 in]
Dimensions	
Row-to-Row Spacing	3 mm[.118 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Durability Rating	250 Cycles
Circuit Application	Signal
Packaging Features	
Packaging Method	Tube

# Product Compliance

For compliance documentation, visit the product page on TE.com>

High Speed Backplane Connectors, 40 Position, Mating Alignment, Center & Dual Mating Alignment Type, 2 Row, 10 Column, PCB Mount Header, Z-PACK HM-Zd+



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

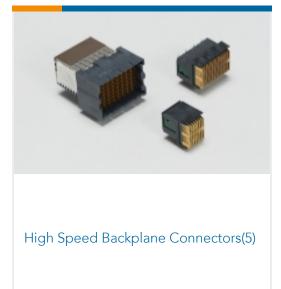
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**



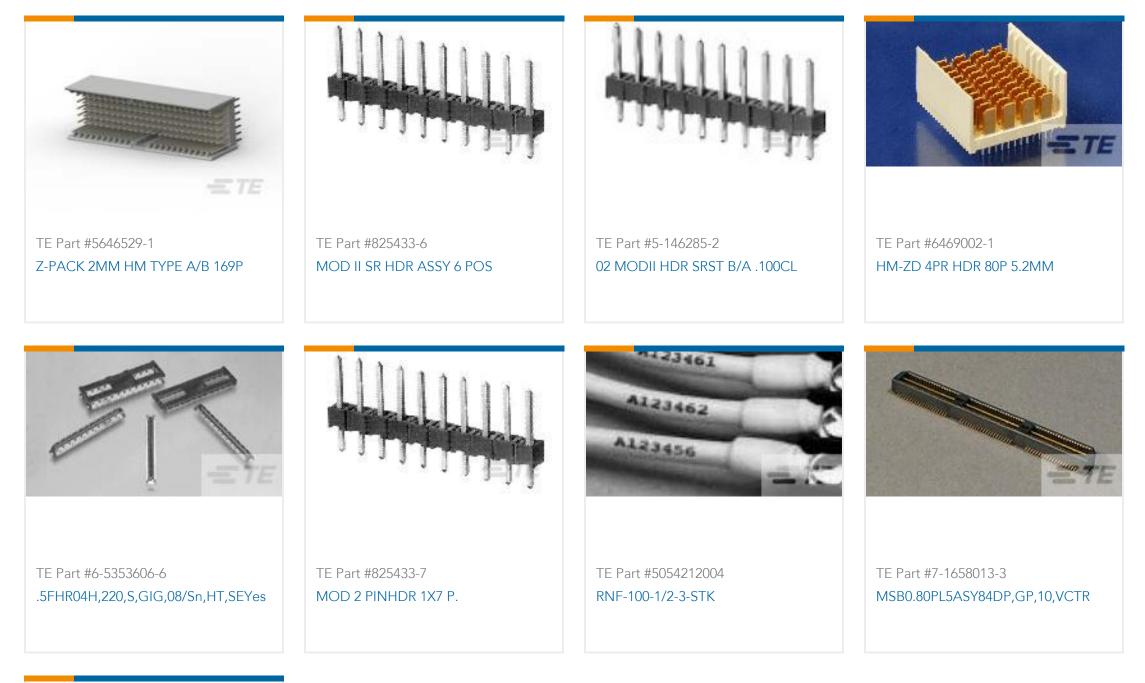
# Also in the Series | Z-PACK HM-Zd+



High Speed Backplane Connectors, 40 Position, Mating Alignment, Center & Dual Mating Alignment Type, 2 Row, 10 Column, PCB Mount Header, Z-PACK HM-Zd+



# Customers Also Bought



TE Part #4-1827253-8

.5FHP05H,220,S,GIG,08/Sn,TR,NSYes

# Documents

Product Drawings HMZD+,2PAIRS,10COLS,VERTICAL,ASSEMBLY

English

### **CAD** Files

Customer View Model ENG\_CVM\_CVM\_2170328-1\_1.2d\_dxf.zip

English

### 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_2170328-1\_1.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_2170328-1\_1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

High Speed Backplane Connectors, 40 Position, Mating Alignment, Center & Dual Mating Alignment Type, 2 Row, 10 Column, PCB Mount Header, Z-PACK HM-Zd+



Product Specifications Application Specification

English

Product Environmental Compliance TE Material Declaration

English